## LMX3162

## Single Chip Radio Transceiver

## General Description

The LMX3162 Single Chip Radio Transceiver is a monolithic, integrated radio transceiver optimized for use in ISM 2.45 GHz wireless systems. It is fabricated using National's ABiC V BiCMOS process ( $\mathrm{f}_{\mathrm{T}}=18 \mathrm{GHz}$ ).
The LMX3162 contains phase locked loop (PLL), transmit and receive functions. The 1.3 GHz PLL is shared between transmit and receive sections. The transmitter includes a frequency doubler, and a high frequency buffer. The receiver consists of a 2.5 GHz low noise mixer, an intermediate frequency (IF) amplifier, a high gain limiting amplifier, a frequency discriminator, a received signal strength indicator (RSSI), and an analog DC compensation loop. The PLL, doubler, and buffers can be used to implement open loop modulation along with an external VCO and loop filter. The circuit features on-chip voltage regulation to allow supply voltages ranging from 3.0 V to 5.5 V . Two additional voltage regulators provide a stable supply source to external discrete stages in the Tx and Rx chains.
The IF amplifier, high gain limiting amplifier, and discriminator are optimized for 110 MHz operation, with a total IF gain of 85 dB . The single conversion receiver architecture provides a low cost, high performance solution for communications systems. The RSSI output may be used for channel quality monitoring.

The Single Chip Radio Transceiver is available in a 48 -pin $7 \mathrm{~mm} \times 7 \mathrm{~mm} \times 1.4 \mathrm{~mm}$ PQFP surface mount plastic package.

## Features

- Single chip solution for ISM 2.45 GHz RF transceiver
- System RF sensitivity to -93 dBm ; RSSI sensitivity to $-100 \mathrm{dBm}$
- Two regulated voltage outputs for discrete amplifiers
- High gain ( 85 dB ) intermediate frequency strip
- Allows unregulated $3.0 \mathrm{~V}-5.5 \mathrm{~V}$ supply voltage
- Power down mode for increased current savings
- System noise figure 6.5 dB (typ)


## Applications

- ISM 2.45 GHz frequency band wireless systems
- Personal wireless communications (PCS/PCN)
- Wireless local area networks (WLANs)
- Other wireless communications systems


## Block Diagram



LMX3162 Connection Diagram


Top View
Order Number LMX3162VBH or LMX3162VBHX See NS Package Number VBH48A

## Pin Descriptions

| Pin No. | Pin Name | I/O | Description |  |
| :---: | :---: | :---: | :---: | :---: |
| 1 | $\mathrm{V}_{\mathrm{cc}}$ | - | Power supply for CMOS section of PLL and ESD bussing. |  |
| 2 | MIXER ${ }_{\text {Out }}$ | 0 | IF output from the mixer. |  |
| 3 | $\mathrm{V}_{\mathrm{CC}}$ | - | Power supply for mixer section. |  |
| 4 | GND | - | Ground. |  |
| 5 | $\mathrm{RF}_{\text {IN }}$ | 1 | RF input to the mixer. |  |
| 6 | GND | - | Ground. |  |

## Pin Descriptions (Continued)

| Pin No. | Pin Name | I/O | Description |  |
| :---: | :---: | :---: | :---: | :---: |
| 7 | Tx V VEG | - | Regulated power supply for external PA gain stage. |  |
| 8 | $\mathrm{V}_{\mathrm{cc}}$ | - | Power supply for analog sections of PLL and doubler. |  |
| 9 | GND | - | Ground. |  |
| 10 | Tx OUT | 0 | Frequency doubler output. |  |
| 11 | GND | - | Ground. |  |
| 12 | $\mathrm{V}_{\mathrm{Cc}}$ | - | Power supply for analog sections of PLL and doubler. |  |
| 13 | GND | - | Ground. |  |
| 14 | GND | - | Ground. |  |
| 15 | $\mathrm{f}_{\mathrm{IN}}$ | 1 | RF Input to PLL and frequency doubler. |  |
| 16 | CE | 1 | Chip Enable. Pulling LOW powers down entire chip. Taking CE HIGH powers up the appropriate functional blocks depending on the state of bits F6, F7, F11, and F12 programmed in F-latch. It is necessary to initialize the internal registers once, after the power up reset. The registers' contents are kept even in power-down condition. |  |
| 17 | $\mathrm{V}_{\mathrm{P}}$ | - | Power supply for charge pump. |  |
| 18 | D。 | 0 | Charge pump output. For connection to a loop filter for driving the input of an external VCO. |  |
| 19 | $\mathrm{V}_{\mathrm{cc}}$ | - | Power supply for CMOS section of PLL and ESD bussing. |  |
| 20 | GND | - | Ground. |  |

Pin Descriptions (Continued)

| Pin No. | Pin Name | I/O | Description |  |
| :---: | :---: | :---: | :---: | :---: |
| 21 | OUT 0 | 0 | Programmable CMOS output. Refer to Function Register Programming Description section for details. |  |
| 22 | Rx PD/OUT 1 | I/O | Receiver power down control input or programmable CMOS output. Refer to Function Register Programming Description section for details. |  |
| 23 | Tx PD/OUT 2 | I/O | Transmitter power down control input or programmable CMOS output. Refer to Function Register Programming Description section for details. |  |
| 24 | PLL PD | 1 | PLL power down control input. LOW for PLL normal operations, and HIGH for PLL power saving. |  |
| 25 | CLOCK | 1 | MICROWIRE ${ }^{\text {TM }}$ clock input. High impedance CMOS input with Schmitt Trigger. |  |
| 26 | DATA | 1 | MICROWIRE data input. High impedance CMOS input with Schmitt Trigger. |  |
| 27 | LE | 1 | MICROWIRE load enable input. High impedance CMOS input with Schmitt Trigger. |  |
| 28 | $\mathrm{OSC}_{\text {IN }}$ | 1 | Oscillator input. High impedance CMOS input with feedback. |  |
| 29 | $\overline{\text { S FIELD }}$ | 1 | DC compensation circuit enable. While LOW, the DC compensation circuit is enabled and the threshold is updated through the DC compensation loop. While HIGH, the switch is opened, and the comparator threshold is held by the external capacitor. |  |
| 30 | RSSI ${ }_{\text {Out }}$ | 0 | Received signal strength indicator (RSSI) output. |  |
| 31 | THRESH | 0 | Threshold level to external comparator. |  |

## Pin Descriptions (Continued)

| Pin No. | Pin Name | I/O | Description |  |
| :---: | :---: | :---: | :---: | :---: |
| 32 | DC COMP ${ }_{\text {IN }}$ | 1 | Input to DC compensation circuit. |  |
| 33 | DISC $_{\text {OUt }}$ | 0 | Demodulated output of discriminator. |  |
| 34 | GND | - | Ground. |  |
| 35 | $\mathrm{V}_{\mathrm{CC}}$ | - | Power supply for the discriminator circuit. |  |
| 36 | QUAD ${ }_{\text {IN }}$ | I | Quadrature input for tank circuit. |  |
| 37 | $\mathrm{V}_{\mathrm{CC}}$ | - | Power supply for limiter output stage. |  |
| 38 | GND | - | Ground. |  |
| 39 | $\mathrm{V}_{\mathrm{CC}}$ | - | Power supply for limiter gain stages. |  |
| 40 | GND | - | Ground. |  |
| 41 | $\mathrm{V}_{\mathrm{CC}}$ | - | Power supply for IF amplifier gain stages. |  |
| 42 | LIM $_{\text {IN }}$ | 1 | IF input to the limiter. |  |
| 43 | GND | - | Ground. |  |
| 44 | $\mathrm{IF}_{\text {OUT }}$ | 0 | IF output from IF amplifier. |  |
| 45 | $\mathrm{V}_{\mathrm{CC}}$ | - | Power supply for IF amplifier output. |  |
| 46 | GND | - | Ground. |  |


| Pin No. | Pin Name | I/O | Description |  |
| :---: | :---: | :---: | :---: | :---: |
| 47 | $\mathrm{IF}_{\text {IN }}$ | I | IF input to IF amplifier. |  |
| 48 | Rx V REG | - | Regulated power supply for external LNA stages. |  |


| Absolute Maximum Ratings (Notes 1,2$)$ |  |
| :--- | ---: |
| Power Supply Voltage $\left(\mathrm{V}_{\mathrm{CC}}\right)$ | -0.3 V to +6.5 V |
| $\mathrm{~V}_{\mathrm{P}}$ | -0.3 V to +6.5 V |
| Voltage on Any Pin with |  |
| GND $=0 \mathrm{~V}\left(\mathrm{~V}_{\mathrm{l}}\right)$ | -0.3 V to $\mathrm{V}_{\mathrm{CC}}+0.3 \mathrm{~V}$ |
| Storage Temperature Range $\left(\mathrm{T}_{\mathrm{S}}\right)$ | $-65^{\circ} \mathrm{C}$ to $+150^{\circ} \mathrm{C}$ |
| Lead Temp. (solder, $4 \sec )\left(\mathrm{T}_{\mathrm{L}}\right)$ | $+260^{\circ} \mathrm{C}$ |

## Recommended Operating Conditions

| Supply Voltage ( $\mathrm{V}_{\mathrm{CC}}$ ) | 3.0 V to 5.5 V |
| :--- | ---: |
| $\left(\mathrm{~V}_{\mathrm{P}}\right)$ | $\mathrm{V}_{\mathrm{CC}}$ to 5.5 V |
| Operating Temperature ( $\mathrm{T}_{\mathrm{A}}$ ) | $-10^{\circ} \mathrm{C}$ to $+70^{\circ} \mathrm{C}$ |
| Note 1: Absolute Maximum Ratings indicate limits beyond which damage to |  |
| the device may occur. Recommended Operating Conditions indicate condi- |  |
| tions for which the device is intended to be functional, but do not guarantee |  |
| specific perfrommance limits. For guaranteed specifications and test condi- |  |
| tions, see the Electrical Characteristics section. The guaranteed specifica- |  |
| tions apply only for the test conditions listed. |  |
| Note 2: This device is a high performance RF integrated circuit with an ESD |  |
| rating < KeV and is ESD sensitive. Handling and assembly of this device |  |
| should only be done at ESD work stations. |  |

## Electrical Characteristics

The following specifications are guaranteed for $\mathrm{V}_{\mathrm{CC}}=3.6 \mathrm{~V}$ and $\mathrm{T}_{\mathrm{A}}=25^{\circ} \mathrm{C}$, unless otherwise specified.

| Symbol | Parameter | Conditions | Min | Typ | Max | Unit |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: |
|  | Current Consumption |  |  |  |  |  |
| $\overline{\mathrm{I}_{\mathrm{CC}, \mathrm{RX}}}$ | -Open-Loop Receive Mode | PLL \& TX chain powered down | - | 50 | 65 | mA |
| $\mathrm{I}_{\text {CC, TX }}$ | -Open-Loop Transmit Mode | PLL \& RX chain powered down | - | 27 | 40 | mA |
| $\mathrm{I}_{\text {CC, PLL }}$ | -PLL only Mode | RX \& TX chain powered down | - | 6 | 9 | mA |
| $\mathrm{I}_{\text {PD }}$ | -Power Down Mode |  | - | - | 70 | $\mu \mathrm{A}$ |
| MIXER |  | $\mathrm{f}_{\mathrm{RF}}=2.45 \mathrm{GHz}, \mathrm{f}_{\text {IF }}=110 \mathrm{MHz}, \mathrm{f}_{\mathrm{LO}}=2340 \mathrm{MHz}\left(\mathrm{f}_{\mathrm{IN}}=1170 \mathrm{MHz}\right)$ |  |  |  |  |
| $\mathrm{f}_{\mathrm{RF}}$ | RF Frequency Range | (Note 3) | 2.4 | - | 2.5 | GHz |
| $\mathrm{f}_{\text {IF }}$ | IF Frequency | (Note 4) | - | 110 | - | MHz |
| $\mathrm{Z}_{\text {IN }}$ | Input Impedance, $\mathrm{RF}_{\text {IN }}$ |  | - | 12+j6 | - | $\Omega$ |
| $\mathrm{Z}_{\text {OUT }}$ | Output Impedance, Mixer Out |  | - | 160-⿺65 | - | $\Omega$ |
| NF | Noise Figure (Single Side Band) | (Notes 5, 6) | - | 11.8 | 16 | dB |
| G | Conversion Gain | (Note 5) | 13 | 17 | - | dB |
| $\mathrm{P}_{1 \mathrm{~dB}}$ | Input 1dB Compression Point | (Note 5) | - | -20 | - | dBm |
| OIP3 | Output 3rd Order Intercept Point | (Note 5) | - | 7.5 | - | dBm |
| $\mathrm{F}_{\text {IN }}-\mathrm{RF}$ | Fin to RF Isolation | $\mathrm{F}_{\text {IN }}=1170 \mathrm{MHz}, \mathrm{RFOUT}=1170 \mathrm{MHz}$ | - | -30 | - | dB |
|  |  | $\mathrm{F}_{\text {IN }}=1170 \mathrm{MHz}, \mathrm{RFOUT}=2340 \mathrm{MHz}$ | - | -20 | - | dB |
|  |  | $\mathrm{F}_{\text {IN }}=1170 \mathrm{MHz}, \mathrm{RFOUT}=3510 \mathrm{MHz}$ | - | -30 | - | dB |
| $\overline{\mathrm{F}_{\text {IN }}-\mathrm{IF}}$ | Fin to IF Isolation | $\mathrm{F}_{\text {IN }}=1170 \mathrm{MHz}, \mathrm{IF}_{\text {OUT }}=1170 \mathrm{MHz}$ | - | -30 | - | dB |
|  |  | $\mathrm{F}_{\text {IN }}=1170 \mathrm{MHz}, \mathrm{IF}_{\text {OUT }}=2340 \mathrm{MHz}$ | - | -30 | - | dB |
|  |  | $\mathrm{F}_{\text {IN }}=1170 \mathrm{MHz}, \mathrm{IF}_{\text {OUT }}=3510 \mathrm{MHz}$ | - | -30 | - | dB |
| RF-IF | RF to IF Isolation | $\mathrm{P}_{\text {IN }}=0$ to -85 dB | - | -30 | - | dB |
| IF AMPLIFIER |  | $\mathrm{f}_{\mathrm{IN}}=110 \mathrm{MHz}$ |  |  |  |  |
| NF | Noise Figure | (Note 7) | - | 8 | 11 | dB |
| $\mathrm{A}_{V}$ | Gain | (Note 7) | 15 | 24 | - | dB |
| $\mathrm{Z}_{\text {IN }}$ | Input Impedance |  | - | 35-j180 | - | $\Omega$ |
| $\mathrm{Z}_{\text {OUT }}$ | Output Impedance |  | - | 210-550 | - | $\Omega$ |
| IF LIMITER |  | $\mathrm{f}_{\mathrm{IN}}=110 \mathrm{MHz}$ |  |  |  |  |
| Sens | Limiter/Discriminator Sensitivity | BER=10 ${ }^{-3}$ (Note 16) | - | -65 | - | dBm |
| $\mathrm{IF}_{\text {IN }}$ | IF Limiter Input Impedance |  | - | 100-j300 | - | $\Omega$ |
| DISCRIMINATOR |  | $\mathrm{f}_{\mathrm{IN}}=110 \mathrm{MHz}$ |  |  |  |  |
|  | Disc Gain | 1X Mode | - | 10 | - | $\mathrm{mV} /{ }^{\circ}$ |
|  | (mV/ of Phase Shift from Tank Circuit) | 3X Mode | - | 33 | - | $\mathrm{mV} /{ }^{\circ}$ |
| $\mathrm{V}_{\text {OUT }}$ | Discriminator Output Peak to Peak Voltage | 1X Mode (Note 8) | 80 | 160 | - | mV |
|  |  | 3X Mode (Note 8) | 400 | 580 | - | mV |
| $\mathrm{V}_{\text {OS }}$ | Disc. Output DC Voltage | Nominal (Note 10) | 1.2 | - | 1.82 | V |
| $\overline{\text { DISC }}$ OUT $^{\text {O }}$ | Disc. Output Impedance |  | - | 300 | - | $\Omega$ |

## Electrical Characteristics (Continued)

The following specifications are guaranteed for $\mathrm{V}_{\mathrm{CC}}=3.6 \mathrm{~V}$ and $\mathrm{T}_{\mathrm{A}}=25^{\circ} \mathrm{C}$, unless otherwise specified.


## VOLTAGE REGULATOR

| $\mathrm{V}_{\mathrm{O}}$ | Output Voltage | $\mathrm{I}_{\text {LOAD }}=5 \mathrm{~mA}$ | 2.55 | 2.75 | 2.90 | V |
| :--- | :--- | :--- | :--- | :--- | :--- | :---: |

DIGITAL INPUT/OUTPUT PINS

| $\mathrm{V}_{\mathrm{IH}}$ | High Level Input Voltage |  | 2.4 | - | - | V |
| :--- | :--- | :--- | :---: | :---: | :---: | :---: |
| $\mathrm{V}_{\mathrm{IL}}$ | Low Level Input Voltage |  | - | - | 0.8 | V |
| $\mathrm{I}_{\mathrm{IH}}$ | Input Current | $\mathrm{GND}<\mathrm{V}_{\mathrm{IN}}<\mathrm{V}_{\mathrm{CC}}$ | -10 | - | 10 | $\mu \mathrm{~A}$ |
| $\mathrm{~V}_{\mathrm{OH}}$ | High Level Output Voltage | $\mathrm{I}_{\mathrm{OH}}=-0.5 \mathrm{~mA}$ | 2.4 | - | - | V |
| $\mathrm{V}_{\mathrm{OL}}$ | Low Level Output Voltage | $\mathrm{I}_{\mathrm{OL}}=0.5 \mathrm{~mA}$ | - | - | 0.4 | V |

Note 3: The mixer section is tested at 2.45 GHz .
Note 4: The IF section of this device is designed for optimum performance at 110 MHz .
Note 5: The matching network used on $\mathrm{RF}_{I N}$ for this measurement consists of a series 3.3 pF capacitance into the pin. The matching circuit used on MIXER sists of a series 150 nH inductance and a shunt 15 pF capacitance into the pin.
Note 6: Noise figure measurements are made with matching networks on $\mathrm{RF}_{\text {IN }}$ and MIXER $\mathrm{O}_{\mathrm{OUT}}$. See (Note 5).
Note 7: The matching network used on pin $\mathrm{IF}_{I N}$ for this measurement conists of a series 330 nH inductance and a shunt 2.7 pF capacitance into the pin. The matching network used on pin IF OUT consists of a series 120 nH inductance and a shunt 12 pF into the pin..
Note 8: The discriminator is with the DC level centered at 1.5 V . The unloaded $Q$ of the tank is 40 .
Note 9: The frequency synthesizer section is tested at 1.225 GHz .
Note 10: Nominal refers to zero DC offsets programmed for the discriminator.
Note 11: It depends on loss of the inter-stage filter. These specifications are for an inter-stage loss of 8 dB .
Note 12: The frequency synthesizer section is guaranteed by design to operate for $\mathrm{OSC}_{\mathbb{I N}}$ input frequency within $5-20 \mathrm{MHz}$ range and minimum amplitude of 0.5 V pp.

Note 13: The doubler section is tested at 2.45 GHz .
Note 14: See Function Register Programming Description for $\mathrm{Icp}_{0}$ description.

## Electrical Characteristics (Continued)

Note 15: Tested in a $50 \Omega$ environment.
Note 16: The matching network used on pin LIM ${ }_{\mathrm{IN}}$ for this measurement consists of a series 330 nH inductance and a shunt 1.8 pF into the pin.
Note 17: The optimum load as seen by the TX OUT pin should be between 50 and 100 ohms.

## Typical Performance Characteristics

## Mixer $\mathrm{P}_{\text {out }}$ vs

$\mathrm{F}_{\text {IN }}$ Power with $\mathrm{RF}_{\text {IN }}=$ -51 dBm , @ $2450 \mathrm{MHz}, 25^{\circ} \mathrm{C}$


RSSI Output vs
Input Power to $\mathrm{IF}_{\text {IN }}$
with $\mathbf{V}_{\mathbf{c c}}$ as Parameter


Mixer $\mathrm{P}_{\text {out }}$ vs
$\mathrm{F}_{\text {IN }}$ Power with $\mathrm{RF}_{\text {IN }}=$
-51 dBm , @ $2450 \mathrm{MHz}, \mathrm{V}_{\mathrm{cc}}=3.6 \mathrm{~V}$


$\mathrm{D}_{\mathrm{O}}$ Voltage, $\mathrm{V}_{\mathrm{cc}}=5.5 \mathrm{~V}$

Typical Performance Characteristics (Continued)

Charge Pump Current vs
$\mathrm{D}_{\mathrm{O}}$ Voltage $\mathrm{V}_{\mathrm{cc}}=3.6 \mathrm{~V}, 25^{\circ} \mathrm{C}$


## Mixer OIP3 vs $\mathrm{F}_{\mathrm{IN}}$ Power



## Mixer Output Power vs Mixer Input Power



Mixer Input Power (dBm), $\mathrm{F}_{\mathrm{IN}}=\begin{array}{r}1170 \mathrm{MHz} \\ \text { DS100929-45 }\end{array}$

## Charge Pump Current vs

$\mathrm{D}_{\mathrm{o}}$ Voltage, $\mathrm{V}_{\mathrm{cc}}=3.0 \mathrm{~V}, 25^{\circ} \mathrm{C}$


## Mixer Gain vs $\mathrm{F}_{\text {IN }}$ Power



Mixer Gain vs $\mathrm{RF}_{\mathrm{IN}}$ Frequency


Typical Performance Characteristics (Continued)

SSB Mixer Noise Figure vs RF ${ }_{\text {IN }}$ Frequency


## TX Power Out vs $\mathrm{F}_{\text {IN }}$ Power



SSB Mixer Noise Figure vs $\mathrm{F}_{\text {IN }}$ Power


TX Power Out vs $\mathrm{F}_{\text {IN }}$ Frequency


## AC Timing Characteristics

## Serial Data Input Timing

TEST CONDITIONS: The Serial Data Input Timing is tested using a symmetrical waveform around $\mathrm{V}_{\mathrm{CC}} / 2$. The test waveform has an skew rate of $0.6 \mathrm{~V} / \mathrm{ns}$.


Notes: Parenthesis data indicates programmable reference divider data.
Data shifted into register on clock rising edge.
Data is shifted in MSB first.

## Serial Data Input Timing (Continued)

| Symbol | Parameter | Conditions | Min | Typ | Max | Unit |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: |
| MICROWIRE ${ }^{\text {TM }}$ Interface |  |  |  |  |  |  |
| $\mathrm{t}_{\mathrm{cs}}$ | Data to Clock Set Up Time | Refer to Test Condition. | 50 | - | - | ns |
| $\mathrm{t}_{\mathrm{CH}}$ | Data to Clock Hold Time | Refer to Test Condition. | 10 | - | - | ns |
| $\mathrm{t}_{\text {cWH }}$ | Clock Pulse Width High | Refer to Test Condition. | 50 | - | - | ns |
| $\mathrm{t}_{\text {cWL }}$ | Clock Pulse Width Low | Refer to Test Condition. | 50 | - | - | ns |
| $\mathrm{t}_{\text {ES }}$ | Clock to Load Enable Set Up Time | Refer to Test Condition. | 50 | - | - | ns |
| $\mathrm{t}_{\text {EW }}$ | Load Enable Pulse Width | Refer to Test Condition. | 50 | - | - | ns |

## PLL Functional Description

The simplified block diagram below shows the building blocks of frequency synthesizer and all internal registers, which are 20-bit data register, 18 -bit F-latch, 13 -bit N -counter, and 5 -bit R-counter.


The DATA stream is clocked into the data register on the rising edge of CLOCK signal, MSB first. The last two bits are the control bits to indicate which register to be written. Upon the rising edge of the LE (Load Enable) signal, the rest of data bits is transferred to the addressed register accordingly. The decoding scheme of the two control bits is as follows:

| Control Bits |  | Register |
| :---: | :---: | :--- |
| C2 | C1 |  |
| 0 | 0 | N-Counter |
| 1 | 0 | R-Counter |
| $X$ | 1 | F-Latch |

Note: $\mathrm{X}=$ Don't Care Condition

## Programmable Feedback Divider ( N -Counter)

The N -counter consists of the 6 -bit swallow counter (A-counter) and the 7 -bit programmable counter (B-counter). When the control bits are " 00 ", data is transferred from the 20 -bit shift register into two latches. One latch sets the A -counter while the other sets the B -counter. The serial data format is shown below.

| MSB |  |  |  |  |  |  |  | GIST | R'S | T | PIN |  |  |  |  |  |  |  | SB |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: |
| 19 | 18 | 17 | 16 | 15 | 14 | 13 | 12 | 11 | 10 | 9 | 8 | 7 | 6 | 5 | 4 | 3 | 2 | 1 | 0 |
| RESERVED |  |  |  |  | N-COUNTER's Divide Ratio |  |  |  |  |  |  |  |  |  |  |  |  | C2 | C1 |
| X | X | X | X | X | N13 | N12 | N11 | N10 | N9 | N8 | N7 | N6 | N5 | N4 | N3 | N2 | N1 | 0 | 0 |

Note: $X=$ Don't Care Condition

## Swallow Counter Divide Ratio (A-Counter)

| Divide Ratio, A | N6 | N5 | N4 | N3 | N2 | N1 |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: |
| 0 | 0 | 0 | 0 | 0 | 0 | 0 |
| 1 | 0 | 0 | 0 | 0 | 0 | 1 |
| $*$ | $*$ | $*$ | $*$ | $*$ | $*$ | $*$ |
| 63 | 1 | 1 | 1 | 1 | 1 | 1 |

Swallow Counter Divide Ratio (A-Counter) (Continued)
Note: Divide ratio must be from 0 to 63 , and $B$ must be $\geq A$.

## Programmable Counter Divide Ratio (B-Counter)

| Divide Ratio, B | N13 | N12 | N11 | N10 | N9 | N8 | N7 |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: |
| 3 | 0 | 0 | 0 | 0 | 0 | 1 | 1 |
| 4 | 0 | 0 | 0 | 0 | 1 | 0 | 0 |
| $*$ | $*$ | $*$ | $*$ | $*$ | $*$ | $*$ | $*$ |
| 127 | 1 | 1 | 1 | 1 | 1 | 1 | 1 |

Note: Divide ratio must be from 3 to 127 , and $B$ must be $\geq$ A.

## Programmable Reference Divider (R-Counter)

If the control bits are " 10 ", data is transferred from the 20 -bit shift register into a latch, which sets the 5 -bit R-counter. The serial data format is shown below.


Note: $\mathrm{X}=$ Don't Care Condition

## Reference Counter Divide Ratio (R-Counter)

| Divide Ratio, R | R5 | R4 | R3 | R2 | R1 |
| :---: | :---: | :---: | :---: | :---: | :---: |
| 3 | 0 | 0 | 0 | 1 | 1 |
| 4 | 0 | 0 | 1 | 0 | 0 |
| $*$ | $*$ | $*$ | $*$ | $*$ | $*$ |
| 31 | 1 | 1 | 1 | 1 | 1 |

Note: Divide ratio must be from 3 to 31 .

## Pulse Swallow Function

$$
f_{v c o}=\frac{[(P \cdot B)+A] \cdot f_{o s c}}{R}
$$

$f_{\text {vco: }}$ : Output frequency of external voltage controlled oscillator (VCO)
$B$ : $\quad$ Preset divide ratio of binary 7-bit programmable counter (3 to 127)
A: Preset divide ratio of binary 6-bit swallow counter ( $0 \leq \mathrm{A} \leq \mathrm{P}, \mathrm{A} \leq \mathrm{B}$ )
$f_{\text {OsC }}$ : Output frequency of the external reference frequency oscillator
$R$ : Preset divide ratio of binary 5-bit programmable reference counter (3 to 31)
$P$ : Preset modulus of dual modulus prescaler (32 or 64)

## Receiver Functional Description

The simplified block diagram below shows the mixer, IF amplifier, limiter, and discriminator. In addition, the DC compensation circuit, doubler, and voltage regulator for an external LNA stage are shown.

Receiver Functional Description (Continued)


Note 18: The receiver can be powered down, either by hardware through the Rx PD pin, or by software through the programming of F6 bit in the F-Latch. The power down control method is determined by the settings of F11 and F12 in F-Latch. (Refer to Function Register Programming Description section for details.) Note 19: The internal capacitor of the discriminator has a value of 1 pF , and has been optimized for operation at 110 MHz .

## Transmitter Functional Description

The simplified block diagram below shows the doubler and voltage regulator for an external transmit gain stage.


Note: The transmitter can be powered down, either by hardware through the Tx PD pin, or by software through the programming of F7 bith in F-Latch. The power down control method is determined by the settings of F11 and F12 in F-Latch. (Refer to Function Register Programming Description section for details.)

## Function Register Programming Description (F-Latch)

If the control bits are " 1 X ", data is transferred from the 20 -bit shift register into the 18 -bit F-latch. Serial data format is shown below.


Note: $\mathrm{X}=$ Don't Care Condition
Various modes of operation can be programmed with the function register bits F1-F18, including the phase detector polarity, charge pump TRI-STATE and CMOS outputs. In addition, software or hardwire power down modes can be specified with bits F11 and F12.

## Function Register Programming Description (F-Latch) (Continued)

| Mode Control Bit | Mode Control Description | Setting to " 0 " to Select | Setting to "1" to Select |
| :---: | :---: | :---: | :---: |
| F1 | Prescaler modules select. | 32/33 | 64/65 |
| F2 | Phase detector polarity. It is used to reverse the polarity of the phase detector according to the VCO characteristics. | Negative VCO Characteristics | Positive VCO Characteristics |
| F3 | Charge pump current gain select. | LOW Charge Pump Current ( $1 \mathrm{X} \mathrm{I}_{\mathrm{cpo}}$ ). | HIGH Charge Pump Current ( $4 \mathrm{X}_{\mathrm{cpo}}$ ). |
| F4 | TRI-STATE charge pump output. | Normal Operation | Force to TRI-STATE |
| F5 | Reserved. Setting to "0" always. | - | - |
| F6 | Receive chain power down control. Software power down can only be activated when both F11 and F12 are set to "0". | Power Up RX Chain | Power Down RX Chain |
| F7 | Transmit chain power down control. Software power down can only be activated when both F11 and F12 are set to "0". | Power Up TX Chain | Power Down TX Chain |
| F8 | Out 0 CMOS output. | OUT 0 = LOW | OUT 0 = HIGH |
| F9 | Out 1 CMOS output. Functions only in software power down mode, when both F11 and F12 are set to "0". | OUT 1 = LOW | OUT 1 = HIGH |
| F10 | Out 2 CMOS output. Functions only in software power down mode, when both F11 and F12 are set to " 0 ". | OUT 2 = LOW | OUT 2 = HIGH |
| $\begin{aligned} & \hline \text { F11 } \\ & \text { F12 } \end{aligned}$ | Power down mode select. <br> Set both F11 and F12 to "0" for software power down mode. Set both F11 and F12 to "1" for hardwire power down mode. Other combinations are reserved for test mode. | Software Power Down | Hardware Power Down |
| F13 | Demodulator gain select | 1X Gain Mode | 3X Gain Mode |
| F14 | Demodulator DC level shift +/- level shifting polarity | Set Negative Polarity | Set Positive Polarity |
| F15 | Demodulator DC level shift of 1.000 V | No Shift | Shift the DC Level by 1.000 V |
| F16 | Demodulator DC level shift of 0.500V | No Shift | Shift the DC Level by 0.500 V |
| F17 | Demodulator DC level shift of 0.250V | No Shift | Shift the DC Level by 0.250 V |
| F18 | Demodulator DC level shift of 0.125V | No Shift | Shift the DC Level by 0.125 V |

## Power Down Mode/Control Table

| Software Power Down Mode (F11=F12=0) |  | Hardwire Power Down Mode (F11=F12=1) |  |  |  |
| :---: | :---: | :---: | :---: | :---: | :---: |
| Pin/Bit | Setting to "0" <br> means | Setting to "1" <br> means | Pin/Bit | Setting to "0" <br> means | Setting to "1" <br> means |
| F6 | Receiver ON | Receiver OFF | Rx PD | Receiver OFF | Receiver ON |
| F7 | Transmitter ON | Transmitter OFF | Tx PD | Transmitter OFF | Transmitter ON |
| PLL PD | PLL ON | PLL OFF | PLL PD | PLL ON | PLL OFF |
| CE | LMX3162 OFF | LMX3162 ON | CE | LMX3162 OFF | LMX3162 ON |

Typical Application


## Loop Filter Design Consideration



## Loop Gain Equations

A linear control system model of the phase feedback for a PLL in the locked state is shown in Figure 2. The open loop gain is the product of the phase comparator gain $\left(\mathrm{K}_{\phi}\right)$, the VCO gain ( $\mathrm{K}_{\mathrm{vco}} / \mathrm{s}$ ), and the loop filter gain $\mathrm{Z}(\mathrm{s})$ divided by the gain of the feedback counter modulus ( N ). The passive loop filter configuration used is displayed in Figure 3, while the complex impedance of the filter is given in Equation (2).


FIGURE 2. PLL Linear Model


FIGURE 3. Passive Loop Filter

## PASSIVE LOOP FILTER

$$
\begin{gather*}
\text { Open loop gain }=\mathrm{H}(\mathrm{~s}) \mathrm{G}(\mathrm{~s})= \\
\theta \mathrm{i} / \theta \mathrm{e}=\mathrm{K}_{\phi} \mathrm{Z}(\mathrm{~s}) \mathrm{K} \mathrm{vco}^{\mathrm{Ns}}  \tag{1}\\
Z(\mathrm{~s})=\frac{\mathrm{s}(C 2 \bullet R 2)+1}{\mathrm{~s}^{2}(C 1 \bullet C 2 \bullet R 2)+\mathrm{s} C 1+\mathrm{s} C 2} \tag{2}
\end{gather*}
$$

The time constants which determine the pole and zero frequencies of the filter transfer function can be defined as

$$
\begin{equation*}
T_{1}=R 2 \cdot \frac{C 1 \cdot C 2}{C 1+C 2} \tag{3}
\end{equation*}
$$

and

$$
\begin{equation*}
T 2=R 2 \cdot C 2 \tag{4}
\end{equation*}
$$

The 3rd order PLL Open Loop Gain can be calculated in terms of frequency, $\omega$, the filter time constants T1 and T2, and the design constants $\mathrm{K}_{\phi}, \mathrm{K}_{\mathrm{vco}}$, and N .

$$
\begin{equation*}
\left.G(S) \bullet H(S)\right|_{S=j \bullet \omega} \frac{-K_{\phi} \bullet K_{V C O}(1+j \omega \bullet T 2)}{\omega^{2} C 1 \bullet N(1+j \omega \bullet T 1)} \bullet \frac{T 1}{T 2} \tag{5}
\end{equation*}
$$

From Equations (3), (4) we can see that the phase term will be dependent on the single pole and zero such that the phase margin is determined in Equation (6).

$$
\begin{equation*}
\phi(\omega)=\tan ^{-1}(\omega \cdot T 2)-\tan ^{-1}(\omega \cdot T 1)+180^{\circ} \tag{6}
\end{equation*}
$$

Physical Dimensions inches (millimeters) unless otherwise noted


## LIFE SUPPORT POLICY

NATIONAL'S PRODUCTS ARE NOT AUTHORIZED FOR USE AS CRITICAL COMPONENTS IN LIFE SUPPORT DEVICES OR SYSTEMS WITHOUT THE EXPRESS WRITTEN APPROVAL OF THE PRESIDENT AND GENERAL COUNSEL OF NATIONAL SEMICONDUCTOR CORPORATION. As used herein:

1. Life support devices or systems are devices or systems which, (a) are intended for surgical implant into the body, or (b) support or sustain life, and whose failure to perform when properly used in accordance with instructions for use provided in the labeling, can be reasonably expected to result in a significant injury to the user.
2. A critical component is any component of a life support device or system whose failure to perform can be reasonably expected to cause the failure of the life support device or system, or to affect its safety or effectiveness.
National Semiconductor
Corporation
Americas
Tel: 1-800-272-9959
Fax: 1-800-737-7018
$\quad$ Email: support@nsc.com
www.national.com
[^0]National Semiconductor
National Semiconductor Asia Pacific Customer
Response Group
Tel: 65-2544466
Fax: 65-2504466
Email: ap.support@nsc.com

Tel: 81-3-5639-7560

## Japan Ltd.

Fax: 81-3-5639-7507
www.national.com


[^0]:    National Semiconductor Europe

    Fax: +49 (0) 180-530 8586 Email: europe.support@nsc.com
    Deutsch Tel: +49 (0) 6995086208
    English Tel: +44 (0) 8702402171
    Français Tel: +33 (0) 141918790

